

DECLARATION OF SOLE INVENTOR FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled: Semiconductor Processing Methods of Forming Integrated Circuitry, Forming Conductive Lines, Forming a Conductive Grid, Forming a Conductive Network, Forming an Electrical Interconnection to a Node Location, Forming an Electrical Interconnection with a Transistor Source/Drain Region, and Integrated Circuitry, the specification of which is attached hereto.

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims.

I acknowledge the duty to disclose information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations §1.56.

**PRIOR FOREIGN APPLICATIONS:**

I hereby state that no applications for foreign patents or inventor's certificates have been filed prior to the date of execution of this declaration.

1                   **POWER OF ATTORNEY:**

2                   As a named Inventor, I hereby appoint the following attorneys and  
3                   agent to prosecute this application and transact all business in the  
4                   Patent and Trademark Office connected therewith: Richard J. St. John,  
5                   Reg. No. 19,363; David P. Roberts, Reg. No. 23,032; Randy A. Gregory,  
6                   Reg. No. 30,386; Mark S. Matkin, Reg. No. 32,268; James L. Price, Reg.  
7                   No. 27,376; Deepak Malhotra, Reg. No. 33,560; Mark W. Hendrickson,  
8                   Reg. No. 32,356; David G. Latwesen, Reg. No. 38,533; George G.  
9                   Grigel, Reg. No. 31,166; Keith D. Grzelak, Reg. No. 37,144; John S.  
10                  Reid, Reg. No. 36,369; Lance R. Sadler, Reg. No. 38,605; James D.  
11                  Shaurette, Reg. No. 39,833; Lia Pappas Dennison, Reg. No. 34,095; and  
12                  Michael L. Lynch, Reg. No. 30,871.

13                  Send correspondence to:    WELLS, ST. JOHN, ROBERTS,  
14                  GREGORY & MATKIN P.S., 601 W. First Avenue, Suite 1300, Spokane,  
15                  WA 99204-0317. Direct telephone calls to:   Mark S. Matkin  
16                  (509) 624-4276.

17                  I hereby declare that all statements made herein of my own  
18                  knowledge are true and that all statements made on information and  
19                  belief are believed to be true; and further that these statements were  
20                  made with the knowledge that willful false statements and the like so  
21                  made are punishable by fine or imprisonment, or both, under

1      Section 1001 of Title 18 of the United States Code and that such willful  
2      false statement may jeopardize the validity of the application or any  
3      patent issued therefrom.

4      \* \* \* \* \*

5      Wendell P. Noble

W.P.N  
2/27/97

5      Full name of sole inventor: Wendell P. Noble

6      Inventor's Signature: Wendell P. Noble

7      Date: 2/27/97

8      Residence:                   Milton, Vermont

9      Citizenship:               U.S.A.

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11                               Milton, VT 05468

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